

M/XIM $800 \mathrm{~mA}, 2 \mathrm{MHz}$, PWM DC-to-DC
Step-Down Converter with

General Description
The MAX1572 is a fixed-frequency, synchronous stepdown DC-to-DC converter to power low-voltage microprocessor/DSP cores in portable equipment requiring high efficiency in a limited PC board area. The features are optimized for high efficiency over a wide load range, small external component size, low output ripple, and excellent transient response. The input supply voltage range is from 2.6 V to 5.5 V , while the output is internally fixed from 0.75 V to 2.5 V in 50 mV increments with a guaranteed output current of 800 mA . The high 2 MHz switching allows tiny low-cost capacitors and a low-profile inductor, while the power-saving pulse-group mode reduces quiescent current to $48 \mu \mathrm{~A}$ (typ) with light loads. To reduce noise and RF interference, the converter can be configured to provide forced-PWM operation.

The MAX1572 includes a low on-resistance internal MOSFET switch and synchronous rectifier to maximize efficiency and minimize external component count. No external diode is needed. Other features include softstart to eliminate inrush current at startup and a 170ms (min) $\overline{\text { RESET }}$ output to provide power-on/undervoltage reset. The MAX1572 is available in a 12-pin, 4mm x 4 mm thin QFN package with exposed paddle.

## Applications

Cell Phones and Smart Phones
PDAs, Palmtops, and Notebook Computers
MP3 and DVD Players
Digital Cameras and Camcorders
PCMCIA Cards
Hand-Held Instruments

## Selector Guide appears at end of data sheet.

Typical Operating Circuit


- Up to 97\% Efficiency
- 2MHz PWM Switching
- 800 mA Guaranteed Output Current
- Low 48 $\mu \mathrm{A}$ Quiescent Current
- Power-Saving Modes: Pulse-Group, Pulse-Skip, Forced-PWM Mode
- 0.75 V to 2.5 V Preset Output Range (in 50 mV Increments)
- Voltage-Positioning Load Transients
- 5mVp-p Output Ripple
- Tiny $2.2 \mu \mathrm{H}$ Inductor
- $10 \mu \mathrm{~F}$ Ceramic Output Capacitor
- Low 0.1 $\mu \mathrm{A}$ Shutdown Current
- No External Schottky Diode Required
- Soft-Start with Zero Inrush Current
- 170 ms (min) $\overline{\text { RESET Output }}$
- Small 12-Pin, $4 \mathrm{~mm} \times 4 \mathrm{~mm}$ Thin QFN Package Ordering Information

| PART | TEMP RANGE | PIN-PACKAGE |
| :---: | :--- | :--- |
| MAX1572ETC075 | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 12 Thin QFN-EP** |
| MAX1572ETC130 | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 12 Thin QFN-EP** |
| MAX1572ETC150 | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 12 Thin QFN-EP** |
| MAX1572ETC180 | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 12 Thin QFN-EP** |
| MAX1572ETC250 | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 12 Thin QFN-EP** |
| MAX1572ETCxyz ${ }^{*}$ | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 12 Thin QFN-EP** |

*xyz is for the output voltage (e.g., MAX1572ETC165 has a 1.65V output). Minimum order quantity is 2500.
${ }^{* *} E P=$ Exposed paddle.
Pin Configuration


## 800mA, 2MHz, PWM DC-to-DC Step-Down Converter with RESET

## ABSOLUTE MAXIMUM RATINGS

ABATT, BATT, EN1, EN2, $\overline{R E S E T}$, OUT,

SS to GND
PGND to GND 0.3 V to +0.3 V

LX Current (Note 1) ............................................................22.1A
Output Short-Circuit Duration Infinite
Continuous Power Dissipation ( $\mathrm{T}_{\mathrm{A}}=+70^{\circ} \mathrm{C}$ )
12-Pin Thin QFN (derate $16.9 \mathrm{~mW} /{ }^{\circ} \mathrm{C}$ above $+70^{\circ} \mathrm{C}$ )... 1349 mW

Operating Temperature Range ........................... $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$
Junction Temperature ...................................................... $+150^{\circ} \mathrm{C}$
Storage Temperature Range ............................. $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$
Lead Temperature (soldering, 10s) ................................. $+300^{\circ} \mathrm{C}$

Note 1: LX has internal clamp diodes to PGND and BATT. Applications that forward bias these diodes should take care not to exceed the IC's package power dissipation limits.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

## ELECTRICAL CHARACTERISTICS

(VBATT $=3.6 \mathrm{~V}, \mathbf{T}_{\mathbf{A}}=+\mathbf{0}^{\circ} \mathbf{C}$ to $\mathbf{+ 8 5}{ }^{\circ} \mathbf{C}$, unless otherwise noted. Typical values are at $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$.)

| PARAMETER | CONDITIONS |  | MIN | TYP | MAX | UNITS |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| BATT Input Voltage |  |  | 2.6 |  | 5.5 | V |
| Undervoltage Lockout Threshold | $V_{\text {BATT }}$ rising and falling, $1 \%$ hysteresis |  | 2.20 | 2.35 | 2.55 | V |
| Quiescent Supply Current | EN1 = GND, EN2 = BATT, no switching |  |  | 48 | 80 | A |
|  | EN1 = BATT, EN2 = GND, no switching |  |  | 700 |  |  |
| Shutdown Supply Current | $\mathrm{EN} 1=\mathrm{EN} 2=\mathrm{GND}, \mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$ |  |  | 0.1 | 1 | $\mu \mathrm{A}$ |
| Maximum Output Current |  |  | 800 |  |  | mA |
| OUT Bias Current |  |  |  | 6 | 9 | $\mu \mathrm{A}$ |
| Output-Voltage Accuracy (Voltage Positioning) | No load, EN1 = EN2 = BATT |  |  | 1.2 | 2.7 |  |
|  | 100mA load |  | -0.4 | +0.8 | +2.0 |  |
|  | 300 mA load |  |  | 0 |  | \% |
|  | 550mA load |  |  | -1 |  |  |
|  | 800mA load |  |  | -2 |  |  |
| Line Regulation |  |  |  | 0.3 |  | \%/V |
| P-Channel On-Resistance | $\mathrm{LLX}=180 \mathrm{~mA}$ | $\mathrm{V}_{\text {BATT }}=3.6 \mathrm{~V}$ |  | 0.28 | 0.45 |  |
|  |  | $V_{\text {BATT }}=2.6 \mathrm{~V}$ |  | 0.33 |  |  |
| N-Channel On-Resistance | $\mathrm{LLX}=180 \mathrm{~mA}$ | $V_{\text {BATT }}=3.6 \mathrm{~V}$ |  | 0.18 | 0.30 | $\Omega$ |
|  |  | $\mathrm{V}_{\text {BATT }}=2.6 \mathrm{~V}$ |  | 0.20 |  |  |
| P-Channel Current-Limit Threshold |  |  | 1.00 | 1.25 | 1.65 | A |
| N-Channel Current-Limit Threshold | EN1 = EN2 = BATT |  | -0.68 | -0.52 | -0.37 | A |
| N-Channel Zero-Crossing Threshold | EN1 = BATT, EN2 = GND |  | 15 | 40 | 65 | mA |
| LX Output Current | (Note 2) |  |  |  | 1.4 | ARMS |
| LX Leakage Current | EN1 = EN2 = GND |  |  | 0.1 | 10 | $\mu \mathrm{A}$ |
| Maximum Duty Cycle |  |  | 100 |  |  | \% |
| Minimum Duty Cycle | $\begin{aligned} & \mathrm{EN} 1=\mathrm{BATT}, \mathrm{EN} 2=\mathrm{GND} \text { or } \\ & \mathrm{EN} 1=\mathrm{GND}, \mathrm{EN} 2=\mathrm{BATT} \end{aligned}$ |  |  | 0 |  | \% |
|  | EN1 $=$ EN2 $=$ BATT |  |  | 16.7 | 17.3 |  |
| Switching Frequency |  |  | 1.8 | 2 | 2.2 | MHz |
| SS Output Impedance |  |  | 65 | 100 | 150 | $\mathrm{k} \Omega$ |

# 800mA, 2MHz, PWM DC-to-DC Step-Down Converter with RESET 

## ELECTRICAL CHARACTERISTICS (continued)

(VBATT $=3.6 \mathrm{~V}, \mathbf{T}_{\mathbf{A}}=+\mathbf{0}^{\circ} \mathbf{C}$ to $\mathbf{+ 8 5}^{\circ} \mathbf{C}$, unless otherwise noted. Typical values are at $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$.)

| PARAMETER | CONDITIONS | MIN | TYP | MAX | UNITS |
| :---: | :---: | :---: | :---: | :---: | :---: |
| SS Discharge Resistance | EN1 = EN2 = GND |  | 100 | 200 | $\Omega$ |
| EN_ Logic Input High | $V_{\text {ABATT }}>4.2 \mathrm{~V}$ | 1.6 |  |  | V |
|  | $\mathrm{V}_{\text {ABATT }} \leq 4.2 \mathrm{~V}$ | 1.4 |  |  |  |
| EN_ Logic Input Low |  |  |  | 0.4 | V |
| EN_ Logic Input Current |  |  | 0.1 | 1 | $\mu \mathrm{A}$ |
| $\overline{\text { RESET Threshold }}$ | Percent of nominal, measured at OUT | 87 | 90 | 93 | \% |
| $\overline{\text { RESET Timer Delay Time }}$ | From Vout $>90 \%$ to $\overline{\text { RESET }}=\mathrm{HI}$ | 170 | 200 | 230 | ms |
| $\overline{\text { RESET Output Low Level }}$ | $\mathrm{ISINK}=1 \mathrm{~mA}$ |  | 0.015 | 0.075 | V |
| $\overline{\text { RESET Internal Pullup Resistance to OUT }}$ |  | 9 | 14 | 20 | k $\Omega$ |
| Thermal-Shutdown Threshold | TJ rising |  | 160 |  | ${ }^{\circ} \mathrm{C}$ |
| Thermal-Shutdown Hysteresis |  |  | 20 |  | ${ }^{\circ} \mathrm{C}$ |

## ELECTRICAL CHARACTERISTICS

(VBATT $=3.6 \mathrm{~V}, \mathbf{T}_{\mathbf{A}}=\mathbf{- 4 0 ^ { \circ }} \mathbf{C}$ to $\mathbf{+ 8 5}^{\circ} \mathbf{C}$, unless otherwise noted.) (Note 3)

| PARAMETER | CONDITIONS | MIN | TYP MAX | UNITS |
| :---: | :---: | :---: | :---: | :---: |
| BATT Input Voltage |  | 2.6 | 5.5 | V |
| Undervoltage Lockout Threshold | VBATT rising and falling, 1\% hysteresis | 2.20 | 2.55 | V |
| Quiescent Supply Current | EN1 = GND, EN2 = BATT, no switching |  | 80 | $\mu \mathrm{A}$ |
| Shutdown Supply Current | EN1 = EN2 = GND |  | 3 | $\mu \mathrm{A}$ |
| Maximum Output Current |  | 800 |  | mA |
| OUT Bias Current |  |  | 9 | $\mu \mathrm{A}$ |
| Output-Voltage Accuracy (Voltage Positioning) | No load, EN1 = EN2 = BATT |  | 3.2 | \% |
|  | 100mA load | -1.2 | +2.8 |  |
| P-Channel On-Resistance | ILX $=180 \mathrm{~mA}$ |  | 0.45 | $\Omega$ |
| N-Channel On-Resistance | $\mathrm{LLX}=180 \mathrm{~mA}$ |  | 0.3 | $\Omega$ |
| N-Channel Current-Limit Threshold | EN1 = EN2 = BATT | -0.68 | -0.22 | A |
| N-Channel Zero-Crossing Threshold | EN1 $=$ BATT, EN2 = GND | 10 | 65 | mA |
| LX Output Current | (Note 2) |  | 1.4 | ARMS |
| LX Leakage Current | EN1 = EN2 = GND |  | 10 | $\mu \mathrm{A}$ |
| Maximum Duty Cycle |  | 100 |  | \% |
| Minimum Duty Cycle | EN1 $=$ EN2 $=$ BATT |  | 17.3 | \% |
| Switching Frequency |  | 1.8 | 2.2 | MHz |
| SS Output Impedance |  | 65 | 150 | $\mathrm{k} \Omega$ |
| SS Discharge Resistance | $\mathrm{EN} 1=\mathrm{EN} 2=\mathrm{GND}$ |  | 200 | $\Omega$ |
| EN_ Logic Input High | $V_{\text {ABATT }}>4.2 \mathrm{~V}$ | 1.6 |  | V |
|  | $\mathrm{V}_{\text {ABATT }} \leq 4.2 \mathrm{~V}$ | 1.4 |  |  |

## 800mA, 2MHz, PWM DC-to-DC Step-Down Converter with RESET

## ELECTRICAL CHARACTERISTICS (continued)

(VBATT $=3.6 \mathrm{~V}, \mathbf{T}_{\mathbf{A}}=\mathbf{- 4 0} \mathbf{C}$ to $\mathbf{+ 8 5}^{\circ} \mathbf{C}$, unless otherwise noted.) (Note 2)

| PARAMETER | CONDITIONS | MIN | TYP MAX | UNITS |
| :---: | :---: | :---: | :---: | :---: |
| EN_ Logic Input Low |  |  | 0.4 | V |
| EN_ Logic Input Current |  |  | 1 | $\mu \mathrm{A}$ |
| RESET Threshold | Percent of nominal, measured at OUT | 87 | 93 | \% |
| $\overline{\text { RESET Timer Delay Time }}$ | From Vout $>90 \%$ to $\overline{\text { RESET }}=\mathrm{HI}$ | 170 | 230 | ms |
| RESET Output Low Level | ISINK $=1 \mathrm{~mA}$ |  | 0.2 | V |
| $\overline{\text { RESET Internal Pullup Resistance to OUT }}$ |  | 9 | 20 | $\mathrm{k} \Omega$ |

Note 2: Guaranteed by design, not production tested.
Note 3: Specifications to $-40^{\circ} \mathrm{C}$ are guaranteed by design and not production tested.
$\left(\mathrm{V}_{\text {BATT }}=3.6 \mathrm{~V}, \mathrm{~V}_{\text {OUT }}=1.5 \mathrm{~V}, \mathrm{EN} 1=\mathrm{GND}, \mathrm{EN} 2=\mathrm{BATT}, \mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}\right.$, unless otherwise noted. $)$


# 800mA, 2MHz, PWM DC-to-DC Step-Down Converter with RESET 

## Typical Operating Characteristics (continued)

$\left(\mathrm{V}_{\mathrm{BATT}}=3.6 \mathrm{~V}, \mathrm{~V}_{\text {OUT }}=1.5 \mathrm{~V}, \mathrm{EN} 1=\mathrm{GND}, \mathrm{EN} 2=\mathrm{BATT}, \mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}\right.$, unless otherwise noted. $)$





2V/div
$10 \mathrm{mV} / \mathrm{div}$
$500 \mathrm{~mA} / \mathrm{div}$


# 800mA, 2MHz, PWM DC-to-DC Step-Down Converter with RESET 

$\left(\mathrm{V}_{\text {BATT }}=3.6 \mathrm{~V}, \mathrm{~V}_{\text {OUT }}=1.5 \mathrm{~V}, \mathrm{EN} 1=\mathrm{GND}, \mathrm{EN} 2=\mathrm{BATT}, \mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}\right.$, unless otherwise noted. $)$


# 800mA, 2MHz, PWM DC-to-DC Step-Down Converter with RESET 

Pin Description

| PIN | NAME | FUNCTION |
| :---: | :---: | :---: |
| 1 | $\overline{\text { RESET }}$ | Active-Low $\overline{\mathrm{RESET}}$ Output. Open-drain output with internal $14 \mathrm{k} \Omega$ pullup to OUT. $\overline{\mathrm{RESET}}$ is driven LOW in shutdown. |
| 2 | SS | Soft-Start Control. Connect a capacitor from SS to GND to set the soft-start time. Use a 1000 pF or larger capacitor to eliminate inrush current during startup. With greater than 10 $\mu \mathrm{F}$ total output capacitance, increase CSS to Cout/10,000 for soft-start. In shutdown, SS is discharged internally with $100 \Omega$ to GND. |
| 3, 5, 11 | GND | Ground. Connect all ground pins to the exposed paddle. |
| 4 | OUT | Output Sense Input. Connect to the output of the regulator. In shutdown, OUT is discharged internally with $14 \mathrm{k} \Omega$ to GND. |
| 6 | EN2 | Enable/Mode Control Input 2. See Table 1. |
| 7 | PGND | Power Ground. Connect to exposed paddle. |
| 8 | LX | Inductor Connection. LX is high impedance in shutdown. |
| 9 | BATT | Supply Voltage Input. Connect to a 2.6 V to 5.5 V source. Connect a $10 \mu \mathrm{~F}$ ceramic capacitor from BATT to GND. |
| 10 | EN1 | Enable/Mode Control Input 1. See Table 1. |
| 12 | ABATT | Analog Supply Input. Connect to BATT through a $10 \Omega$ resistor. Connect a $0.1 \mu \mathrm{~F}$ capacitor from ABATT to GND. |
| - | Exposed Paddle | Exposed Paddle. Connect to GND and PGND. |

## Table 1. Mode Select Truth Table

| MODE | EN1 | EN2 |
| :--- | :---: | :---: |
| Shutdown | 0 | 0 |
| Pulse group | 0 | 1 |
| Pulse skip | 1 | 0 |
| Forced PWM | 1 | 1 |

A zero represents EN_ being driven low or connected to GND. A 1 represents EN_ being driven high or connected to BATT.

## Detailed Description

Figure 1 is the functional diagram.
PWM Control Scheme
The MAX1572 uses a 2 MHz fixed-frequency, pulse-width-modulated (PWM), current-mode control scheme. The heart of the current-mode PWM controller is an open-loop comparator that compares the error amp voltage-feedback signal against the sum of the amplified current-sense signal and the slope compensation ramp. At each rising edge of the internal clock, the internal high-side P-channel MOSFET turns on until the PWM comparator trips. During this on-time, current ramps up through the inductor, sourcing current to the


Figure 1. Functional Diagram

# 800mA, 2MHz, PWM DC-to-DC Step-Down Converter with RESET 

output and storing energy in the inductor's magnetic field. The current-mode feedback system regulates the peak inductor current as a function of the output voltage error signal. Since the average inductor current is nearly the same as the peak inductor current (assuming that the inductor value is relatively high to minimize ripple current), the circuit acts as a switch-mode transconductance amplifier. This pushes the output LC filter pole, normally found in a voltage-mode PWM, to a higher frequency. To preserve inner-loop stability and eliminate inductor staircasing, an internal slope-compensation ramp is summed into the main PWM comparator. During the second half of the switching cycle (off-time), the internal high-side P-channel MOSFET turns off and the internal low-side N-channel MOSFET turns on. Now the inductor releases the stored energy as its current ramps down while still providing current to the output. The output capacitor stores charge when the inductor current exceeds the load current and discharges when the inductor current is lower, smoothing the voltage across the load. Under overload conditions, when the inductor current exceeds the current limit, the high-side MOSFET is turned off and the low-side MOSFET remains on for the remainder of the cycle to let the inductor current ramp down.

Pulse-Group Mode
Pulse-group mode is used to minimize the supply current with a light load. In pulse-group mode, the IC shuts off most internal circuitry when VOUT is $+0.8 \%$ above nominal regulation. When Vout drops below $+0.8 \%$ of the nominal regulation voltage, the IC powers up its circuits and resumes switching.

Pulse-Skip Mode
Pulse-skip mode is also used to minimize the supply current with a light load. The difference between pulsegroup and pulse-skip modes is that when VOUT rises above the $+0.8 \%$ regulation point, pulse-group mode stops switching and completely turns off a number of circuits. Under the same conditions, pulse-skip mode stops switching but leaves all circuits on. The delay coming out of pulse-skip mode is shorter than with
pulse-group mode. In pulse-skip mode, the output voltage ripple is lower, and the load-transient response faster. However, the quiescent current is higher than in pulse-group mode.

## Forced-PWM Mode

 In forced-PWM mode, the MAX1572 operates at a constant 2 MHz switching frequency without pulse skipping. This is desirable in noise-sensitive applications, since the output ripple is minimized and has a predictable noise spectrum. Forced-PWM mode requires higher supply current with light loads due to constant switching.
## 100\% Duty-Cycle Operation

The MAX1572 can operate at 100\% duty cycle. In this state, the high-side P-channel MOSFET is turned on (not switching). This occurs when the input voltage is close to the output voltage. The dropout voltage is the voltage drop due to the output current across the on-resistance of the internal P-channel MOSFET (RDS(ON)P) and the inductor resistance ( $\mathrm{RL}_{\mathrm{L}}$ ):

$$
\text { VDROPOUT }=\text { IOUT } \times\left(R_{D S(O N) P}+R_{L}\right)
$$

RDS(ON)P is given in the Electrical Characteristics section. RL, for a few recommended inductors, is given in Table 2.

## Load-Transient Response/ Voltage Positioning

The MAX1572 uses voltage positioning that matches the load regulation to the voltage droop seen during load transients. In this way, the output voltage does not overshoot when the load is removed, which results in the total output-voltage variation being half as wide as in a conventional design. Figure 2 shows an example of a voltage-positioned and a nonvoltage-positioned load transient. Additionally, the MAX1572 uses a wide-bandwidth feedback loop to respond more quickly to a load transient than regulators using conventional integrating feedback loops.
The load line used to achieve voltage positioning is shown in Figure 3. This assumes a nominal operating point of 3.6 V input at 300 mA load.

Table 2. Recommended Inductors

| MANUFACTURER | PART | VALUE $(\boldsymbol{\mu H})$ | $\mathbf{R L}_{\mathbf{L}}(\mathbf{m} \Omega)$ | ISAT $(\mathbf{m A})$ | SIZE (mm) | SHIELDED |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Murata | LQH32CN | 2.2 | 97 | 790 | $2.5 \times 3.2 \times 2.0$ | No |
| Sumida | CDRH3D16 | 2.2 | 50 | 1200 | $3.8 \times 3.8 \times 1.8$ | Yes |
|  | CDRH2D11 | 2.2 | 78 | 780 | $3.2 \times 3.2 \times 1.2$ | Yes |
| TOKO | D312F | 2.2 | 170 | 1200 | $3.6 \times 3.6 \times 1.2$ | No |
|  | D412F | 2.2 | 140 | 1330 | $4.8 \times 4.8 \times 1.2$ | No |

# 800mA, 2MHz, PWM DC-to-DC Step-Down Converter with RESET 



Figure 2. Load Transient Response, With and Without Voltage Positioning

## Soft-Start

Soft-start is used to prevent input-current overshoot during startup. For most applications using a $10 \mu \mathrm{~F}$ output capacitor, connect a 1000 pF capacitor from SS to GND. If a larger output capacitor is used, then use the following formula to find the value of the soft-start capacitor needed to prevent input-current overshoot:
CsS = Cout /104

During soft-start, the output voltage rises from 0 to VOUT(nom) with a time constant equal to Css times $100 \mathrm{k} \Omega$ (see the Typical Operating Characteristics).

170ms RESET
$\overline{\text { RESET }}$ is an open-drain output with an internal $14 \mathrm{k} \Omega$ pullup resistor to OUT. During startup, RESET is held low until 200 ms (typ) after the output voltage reaches $90 \%$ of its nominal regulation voltage. When the output voltage drops below $90 \%$ of its nominal regulation voltage, RESET pulls low again. See the Typical Operating Characteristics section for RESET waveforms during startup and shutdown.

## Applications Information

## Inductor Selection

A 2.2 $\mu \mathrm{H}$ inductor with a saturation current of at least 1 A is recommended for full-load $(800 \mathrm{~mA})$ applications. For lower load currents, the inductor current rating may be reduced. For most applications, use an inductor with a current rating 1.25 times the maximum required output


Figure 3. Voltage-Positioning Load Line
current. For maximum efficiency, the inductor's DC resistance should be as low as possible. See Table 2 for recommended inductors and manufacturers.

## Capacitor Selection

Ceramic $10 \mu \mathrm{~F}$ input and output capacitors are recommended for most applications. For output voltages below 1.5 V , output capacitance should be increased to $22 \mu \mathrm{~F}$. For best stability over a wide temperature range, use capacitors with an X5R or better dielectric.

## ABATT Input Filter

In normal applications, an RC filter on ABATT keeps power-supply noise from entering the IC. Connect a $10 \Omega$ resistor between BATT and ABATT and connect a $0.1 \mu \mathrm{~F}$ capacitor from ABATT to GND.

PC Board Layout and Routing
Due to fast-switching waveforms and high-current paths, careful PC board layout is required. An evaluation kit (MAX1572EVKIT) is available to speed design.
When laying out a board, minimize trace lengths between the IC, the inductor, the input capacitor, and the output capacitor. Keep these traces short, direct, and wide. Keep noisy traces, such as the LX node trace, away from OUT. The input bypass capacitors should be placed as close to the IC as possible. Connect PGND and GND directly to the exposed paddle underneath the IC. The ground connections of the input and output capacitors should be as close together as possible.

# 800mA, 2MHz, PWM DC-to-DC Step-Down Converter with RESET 

$\qquad$

| PART | VOUT (V) | TOP MARK |
| :---: | :---: | :---: |
| MAX1572ETC075 | 0.75 | AABW |
| MAX1572ETC130 | 1.30 | AACW |
| MAX1572ETC150 | 1.50 | AABX |
| MAX1572ETC180 | 1.80 | AABY |
| MAX1572ETC250 | 2.50 | AABZ |
| MAX1572ETCxyz | ${ }^{*}$ | - |

${ }^{*} x y z$ is for output voltage (e.g., MAX1572ETC165 has a 1.65 V output).

Package Information
(The package drawing(s) in this data sheet may not reflect the most current specifications. For the latest package outline information, go to www.maxim-ic.com/packages.)


# 800mA, 2MHz, PWM DC-to-DC Step-Down Converter with RESET 

Package Information (continued)
(The package drawing(s) in this data sheet may not reflect the most current specifications. For the latest package outline information, go to www.maxim-ic.com/packages.)

| CDMMDN DIMENSIDNS |  |  |  |  |  |  |  |  |  |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| PKG | 12L $4 \times 4$ |  |  | 16L $4 \times 4$ |  |  | 20L $4 \times 4$ |  |  | 24L $4 \times 4$ |  |  |
| REF, | MIN. | NDM | MAX. | MIN | NDM. | MAX. | MIN. | NDM. | MAX. | MIN. | NDM. | MAX |
| A | 0.70 | 0.75 | 0.80 | 0.70 | 0.75 | 0.80 | 0.70 | 0.75 | 0.80 | 0.70 | 0.75 | 0.80 |
| A1 | 0.0 | 0.02 | 0.05 | 0.0 | 0.02 | 0.05 | 0.0 | 0.02 | 0.05 | 0.0 | 0.02 | 0.05 |
| A2 | 0.20 REF |  |  | 0.20 REF |  |  | 0.20 REF |  |  | 0.20 REF |  |  |
| $b$ | 0.25 | 0.30 | 0.35 | 0.25 | 0.30 | 0.35 | 0.20 | 0.25 | 0.30 | 0.18 | 0.23 | 0.30 |
| D | 3.90 | 4.00 | 4.10 | 3.90 | 4.00 | 4.10 | 3.90 | 4.00 | 4.10 | 3.90 | 4.00 | 4.10 |
| E | 3.90 | 4.00 | 4.10 | 3.90 | 4.00 | 4.10 | 3.90 | 4.00 | 4.10 | 3.90 | 4.00 | 4.10 |
| e | 0.80 BSC. |  |  | 0.65 BSC. |  |  | 0.50 BSC. |  |  | 0.50 BSC. |  |  |
| k | 0.25 | - | - | 0.25 | - | - | 0.25 | - | - | 0.25 | - | - |
| L | 0.45 | 0.55 | 0.65 | 0.45 | 0.55 | 0.65 | 0.45 | 0.55 | 0.65 | 0.30 | 0.40 | 0.50 |
| N | 12 |  |  | 16 |  |  | 20 |  |  | 24 |  |  |
| ND | 3 |  |  | 4 |  |  | 5 |  |  | 6 |  |  |
| NE | 3 |  |  | 4 |  |  | 5 |  |  | 6 |  |  |
| Jedec | WGGB |  |  | WGGC |  |  | WGGD-1 |  |  | WGGD-2 |  |  |


| EXPGSED PAD VARIATIDNS |  |  |  |  |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| PKG. CDDES | D2 |  |  | E2 |  |  | DOWN BCNDS ALLIVED |
|  | MIN, | NDM. | MAX. | MIN, | NDM. | MAX. |  |
| T1244-2 | 1.95 | 2.10 | 2.25 | 1.95 | 2.10 | 2.25 | NO |
| T1244-3 | 1.95 | 2.10 | 2.25 | 1.95 | 2.10 | 2.25 | YES |
| T1244-4 | 1.95 | 2.10 | 2.25 | 1.95 | 2.10 | 2.25 | NO |
| T1644-2 | 1.95 | 2.10 | 2.25 | 1.95 | 2.10 | 2.25 | N0 |
| T1644-3 | 1.95 | 2.10 | 2.25 | 1.95 | 2.10 | 2.25 | YES |
| T1644-4 | 1.95 | 2.10 | 2.25 | 1.95 | 2.10 | 2.25 | N0 |
| T2044-1 | 1.95 | 2.10 | 2.25 | 1.95 | 2.10 | 2.25 | NO |
| T2044-2 | 1.95 | 2.10 | 2.25 | 1.95 | 2.10 | 2.25 | YES |
| T2044-3 | 1.95 | 2.10 | 2.25 | 1.95 | 2.10 | 2.25 | ND |
| T2444-1 | 2.45 | 2.60 | 2.63 | 2.45 | 2.60 | 2.63 | NO |
| T2444-2 | 1.95 | 2.10 | 2.25 | 1.95 | 2.10 | 2.25 | YES |
| T2444-3 | 2.45 | 2.60 | 2.63 | 2.45 | 2.60 | 2.63 | YES |
| T2444-4 | 2.45 | 2.60 | 2.63 | 2.45 | 2.60 | 2.63 | NO |

## notes:

1. DIMENSIONING \& TOLERANCING CONFORM TO ASME Y14.5M-1994.
2. ALL dimensions are in millimeters. angles are in degrees.
3. $N$ IS THE TOTAL NUMBER OF TERMINALS.
4. THE TERMINAL \#1 IDENTIFIER AND TERMMNL NUMBERING CONVENTON SHALL CONFORM TO

JESD 95-1 SPP-012. DEEALS OF TERMNAL \#1 IDENTFIER ARE OPTIONAL, BUT MUST BE LDCATED WTHIN THE ZONE INOLCATED. THE TERNINAL \#1 IDENTIFIER MAY BE ETHER A MOLD OR MARKED FEATURE.
全. DIMENSION b APPLES TO METALIZED TERMINAL AND IS MEASURED BETWEEN 0.25 mm AND 0.30 mm FROM TERMINAL TIP.
6. ND and ne refer to the number of terminals on each d and e side respectively.
7. depopulation is possible in a sYmmetrical fashion.
8. COPLANARITY APPLIES TO THE EXPOSED HEAT SINK SLUG AS WELL AS THE TERMINALS.
9. DRAWING CONFORMS TO JEDEC MO220, EXCEPT FOR T2444-1, T2444-3 AND T2444-4.


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